INFORMATION

PRODUCT No. : **Q33519EA0001800**

MODEL : **SG-8003CE**

INFO. No. : **A14-449-1A**

DATE : **Jul. 14. 2014**

SEIKO EPSON CORPORATION

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INTRODUCTION

1. The contents is subject to change without notice.
   Please exchange the specification sheets regarding
   the product's warranty.

2. This sheet is not intended to guarantee or provide
   an approval of implementation of industrial patents.

3. We have prepared this sheet as carefully as possible.
   If you find it incomplete or unsatisfactory in any
   respect, We would welcome your comments.

This product is compliant with RoHS Directive.

This Product supplied (and any technical information furnished, if any) by Seiko Epson Corporation shall not be used for the development and manufacture of weapon of mass destruction or for other military purposes.
Making available such products and technology to any third party who may use such products or technologies for the said purposes are also prohibited.

This product listed here is designed as components or parts for electronics equipment in general consumer use.
We do not expect that any of these products would be incorporated or otherwise used as a component or part for the equipment, which requires an extra high reliability, such as satellite, rocket and other space systems, and medical equipment, the functional purpose of which is to keep life.

Product No. / Model

The product No. of this crystal oscillator unit is Q33519EA0001800.
The model is SG-8003CE.

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[1] Absolute maximum ratings

Parameter	Symbol	Value	Unit	Note
Supply voltage	V_{CC}-GND	-0.5 to +4.4	V	
Storage temperature *	T_stg	-40 to +125	°C	Stored as bare product after unpacking.
Input voltage	V_{IN}	-0.5 to V_{CC}+0.5	V	OE Terminal

* Concerning the frequency change, please refer [8] Environmental and mechanical characteristics.

[2] Operating range

Parameter	Symbol	Value			Unit	Note
		Min.	Typ.	Max.		
Supply voltage	V_{CC}	2.2	2.5	2.8	V	
Supply voltage	GND	0.0	0.0	0.0	V	
Input voltage	V_{IN}	GND	-	V_{CC}	V	
Output load condition	L_CMOS	-	-	15	pF	

- Start up time must be increased linearly and (0 %V_{CC}→90 %V_{CC}) of power source should be between 150μs to 500ms.
- By-pass capacitor (0.01 μF to 0.1 μF) is connected near Vcc between Vcc and GND.

[3] Frequency characteristics

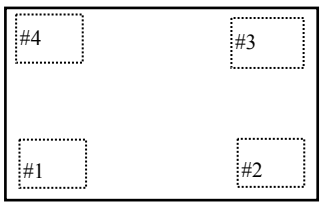
1) Output frequency (f_0) range ..... 1.0000 MHz to 166.0000 MHz
2) Output frequency fo ..... Please see Output frequency list

Parameter	Symbol	Value[1×10^{-6}]	Note
Frequency tolerance *	f_tol (OSC)	M: ± 100 L: ± 50	T_use=-40 °C to +85 °C
		C: ± 100 B: ± 50	T_use=-20 °C to +70 °C
Aging	f_aging	± 3	T_use=+25 °C, V_{CC}=1.8 V First year

* This includes initial frequency tolerance, temperature characteristics, input voltage characteristics, load characteristics and Reflow shift, but excludes aging.

[4] Terminal assignment

Top View



Terminal name	Terminal No.	Terminal type.
OE	1	INPUT
GND	2	—
OUT	3	OUTPUT
V_{CC}	4	—

OE pin : High or open. → Specified frequency output = enable.
OE pin : Low. → Output is weak pull-down = abled.

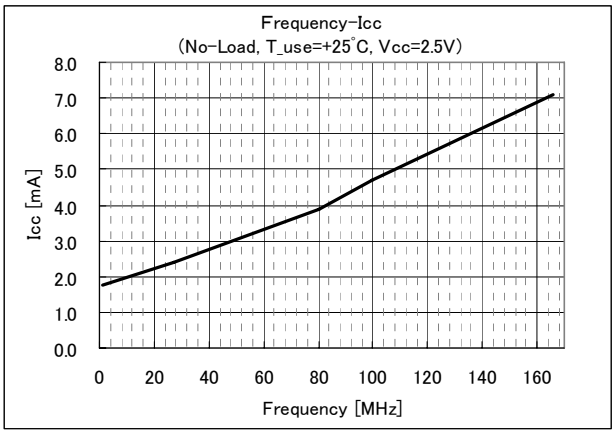
[5] Electrical characteristics

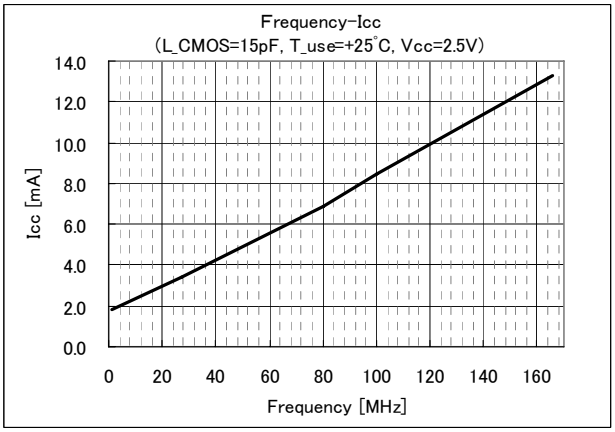
(Please see page 2 [2] Operating range)

Parameter	Symbol	Value Min.	Value Max.	Unit	Note	
Start up time	tOSC	-	5	ms	t=0 at 90 %Vcc	
Current consumption	ICC	-	4	mA	1 MHz≦f_0≦25 MHz, No load	
			6.5		25 MHz<f_0≦50 MHz, No load	
			8.5		50 MHz<f_0≦75 MHz, No load	
			10.5		75 MHz<f_0≦100 MHz, No load	
			12.5		100 MHz<f_0≦125 MHz, Noload	
			15		125 MHz<f_0≦166 MHz, No load	
Disable current	I_dis	-	8	mA	OE=GND	
Output rise time	tr	-	5	ns	20 %Vcc → 80 %Vcc	1 MHz≦f0＜80 MHz
			2.5			80 MHz≦f0≦166 MHz
Output fall time	tf	-	5	ns	80 %Vcc → 20 %Vcc	1 MHz≦f0＜80 MHz
			2.5			80 MHz≦f0≦166 MHz
Symmetry	SYM	45	55	%	50 %VccLevel	
High level output voltage	VOH	0.9 Vcc	-	V	IOH = -4 mA	
Low level output voltage	VOL	-	0.1 Vcc	V	IOL = 4 mA	
High level input voltage	VIH	0.8 Vcc	-	V	OE terminal	
Low level input voltage	VIL	-	0.2 Vcc	V	OE terminal	
Input current	IIH	-5	5	μA	VIN = VCC	
	IIL	—	10	μA	VIN = GND	
Jitter (cycle to cycle)	tj	—	1%T_{OUT}	ps	1 MHz ≤fo≤27 MHz, T_{OUT}=1/ F_0	
		—	200		27 MHz ≤fo≤166 MHz	
Jitter (peak to peak)		—	1%T_{OUT}		1 MHz ≤fo≤27 MHz, T_{OUT}=1/ F_0	
		—	250		27 MHz ≤fo≤166 MHz	
Output disable time	t_{pxz}	—	100	ns	OE terminal HIGH → LOW	
Output enable time	t_{pzx}	—	100	ns	OE terminal LOW → HIGH	
Input pull-up resistance	R_{UP}	1.0	6.0	MΩ	disable time VIn=0V	
		100	250	KΩ	enable time VIn≧0.8Vcc, Ta=+25 ℃	

Refer to [6] Test circuit [7] Timing chart

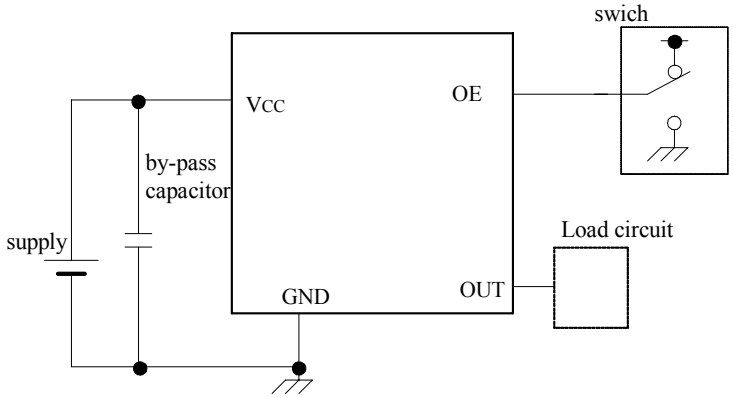
Current consumption (Reference value) (Vcc=2.5 V , T_use=25 ˚C)



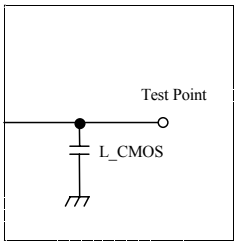


[6] Test circuit

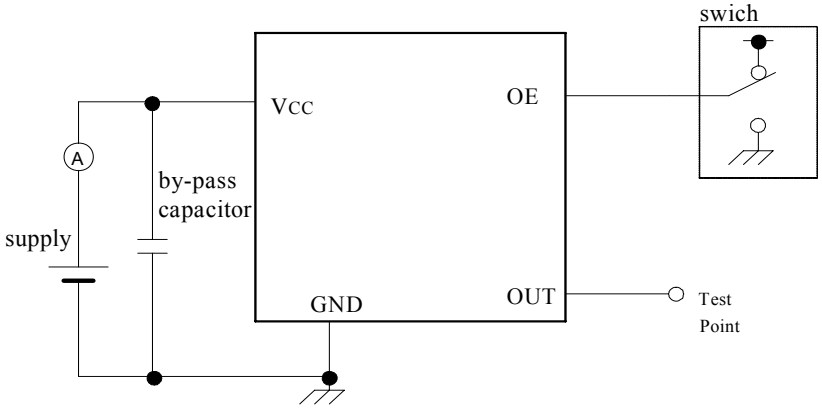
1) Waveform observation



Load circuit load capacitance



2) Current consumption



*Current consumption under the disable function should be OE= GND.

3) Condition

(1) Oscilloscope

- Band width should be minimum 5 times higher (wider) than measurement frequency.
- Probe earth should be placed closely from test point and lead length should be as short as possible.

* Recommendable to use miniature socket. (Don't use earth lead.)

(2) L_CMOS also includes probe capacitance.

(3) By-pass capacitor (0.01 μF to 0.1 μF) is placed closely between VCC and GND.

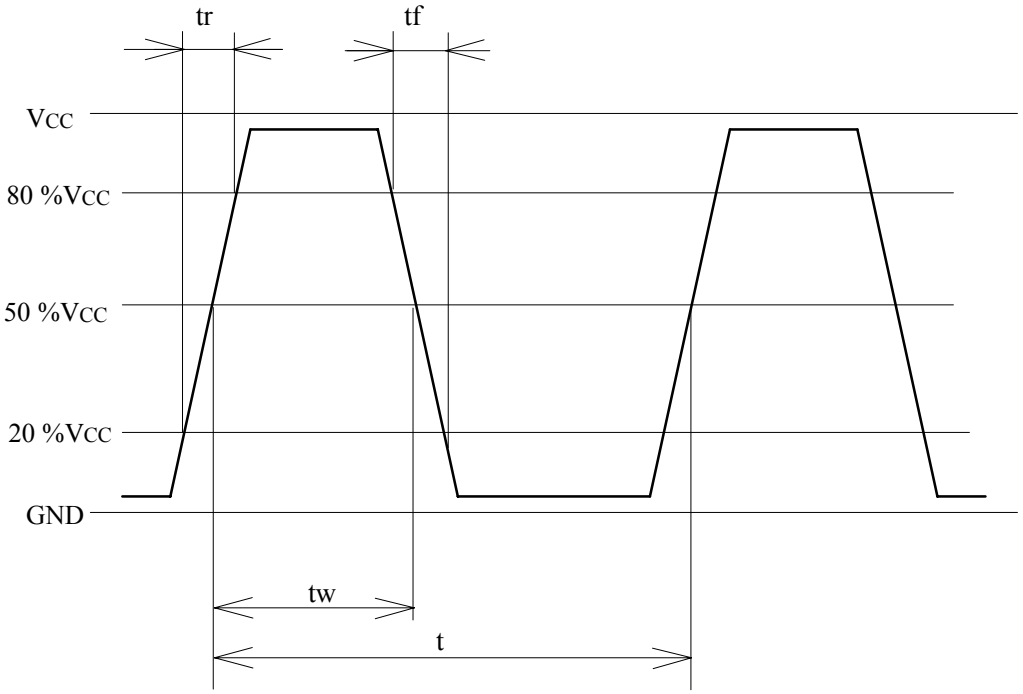
(4) Use the current meter whose internal impedance value is small.

(5) Power supply

- Start up time (0 %VCC → 90 %VCC) of power source should be between 150μs to 500ms.
- Impedance of power supply should be as lowest as possible.

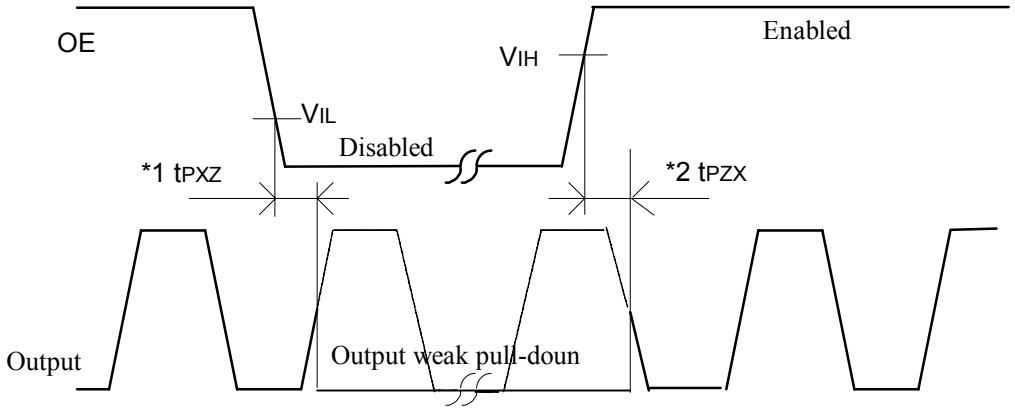
[7] Timing chart

1) C-MOS load SYM = tw/t × 100 (%)



2) OE function and timing

OE function	Osc. circuit	Output status
High or Open	Oscillation	Specified frequency is output : Enable
Low	Oscillation	Output becomes weak pull-down : Disable



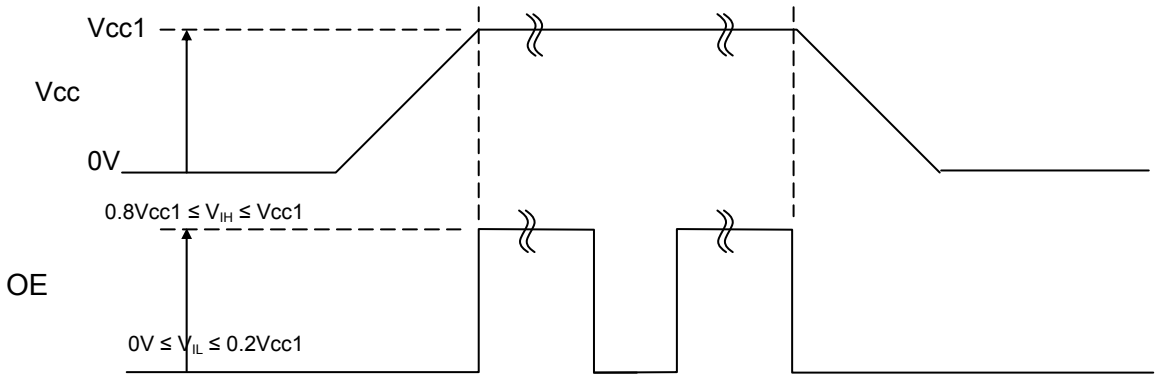
*1 The time taken from OE=VIL to output = Disable (weak pull-doun)

*2 The time taken from OE=VIH to output = Start

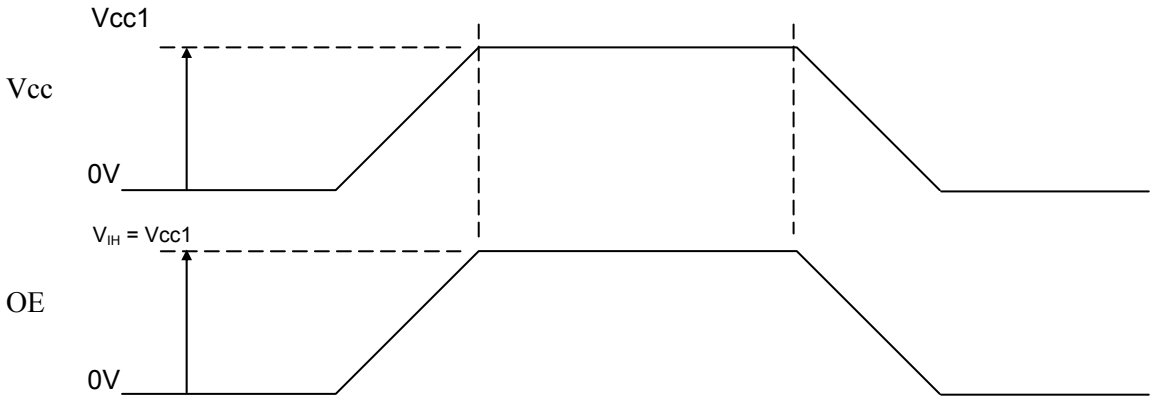
3) OE control timing

OE function is used on the voltage below supply voltage.

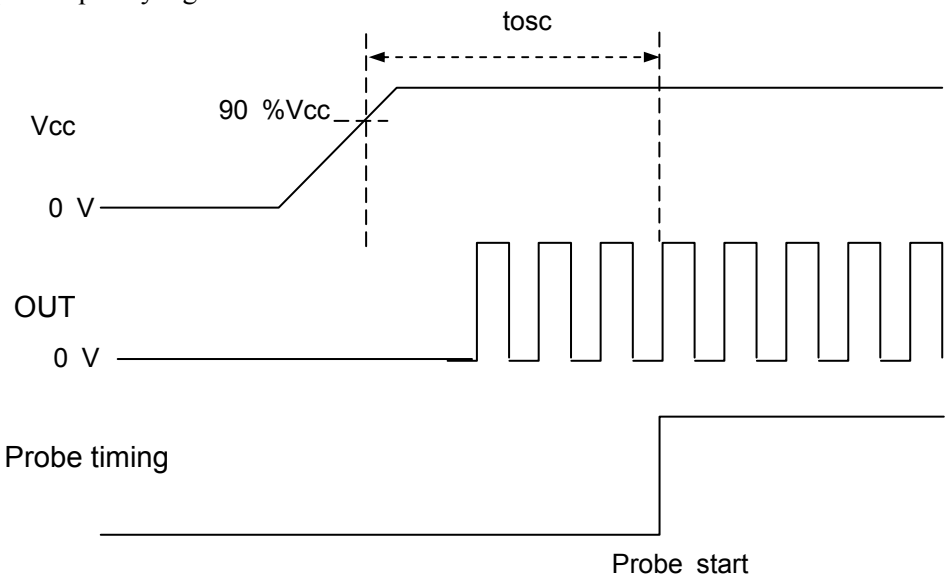
OE control timing differs from Vcc control timing



OE terminal is connected to Vcc terminal



4) Timing of an output frequency signal



[8] Environmental and mechanical characteristics

(The company evaluation condition We evaluate it by the following examination item and examination condition.)

No.	Item	Value *1		Test Conditions
		Δ f / f *2 [1×10^{-6}]	Electrical characteristics	
1	High temperature storage	*3 ± 20	Satisfy Item [5] after test.	+125 °C × 1 000 h
2	Low temperature storage	*3 ± 10		-40 °C × 1 000 h
3	High temperature bias	*3 ± 10		+85 °C × Vcc Max. × 1 000 h
4	Low temperature bias	*3 ± 10		-40 °C × Vcc Max. × 1 000 h
5	Temperature humidity bias	*3 ± 10		+85 °C × 85 %RH × Vcc Max. × 1 000 h
6	Temperature cycle	*3 ± 10		-40 °C ↔ +125 °C 30 min. at each temperature 100 cycles
7	Resistance to soldering heat	± 3		Convection reflow soldering furnace (3 time) Ref. IPC/JEDEC J-STD-020D.1
8	Shock	± 3		100 g dummy Jig (SE Standard) drop from 1 500 mm height on the Concrete 3 directions 10 times.
9	Vibration	± 2		10 Hz to 55 Hz amplitude 0.75 mm 55 Hz to 500 Hz acceleration 98 m/s^2 10 Hz → 500 Hz → 10 Hz 15 min./cycle 6 h (2 hours , 3 directions)
10	Seal	1×10^{-9} Pa·m^3 / s		He leakage detector
11	Solderability	Termination must be 95 % covered with fresh solder		Dip termination into solder bath at +235 °C ± 5 °C for 5 s. (Using Rosin Flux)
12	Pull - off	No peeling-off at a solder part		10 N press for 10 s ± 1 s Ref. EIAJ ED-4702

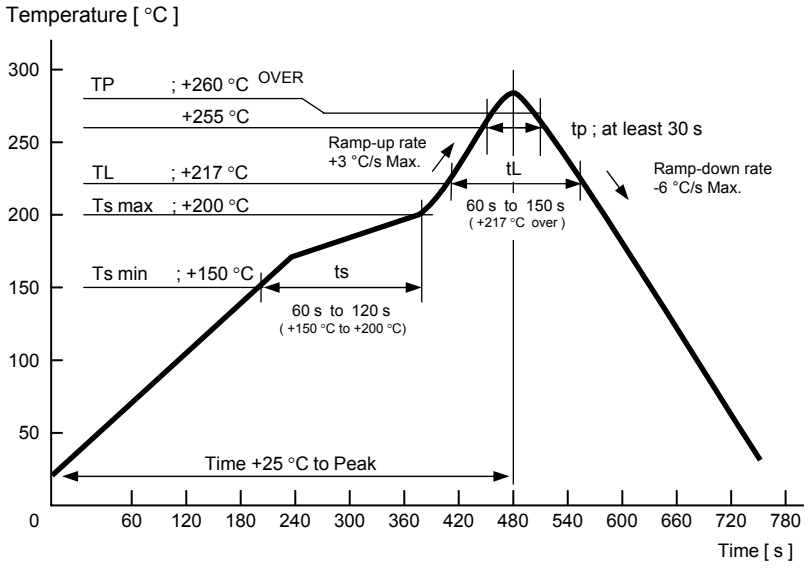
< Notes >

*1 Each test done independently.

*2 Measuring 2 h to 24 h later leaving in room temperature after each test.

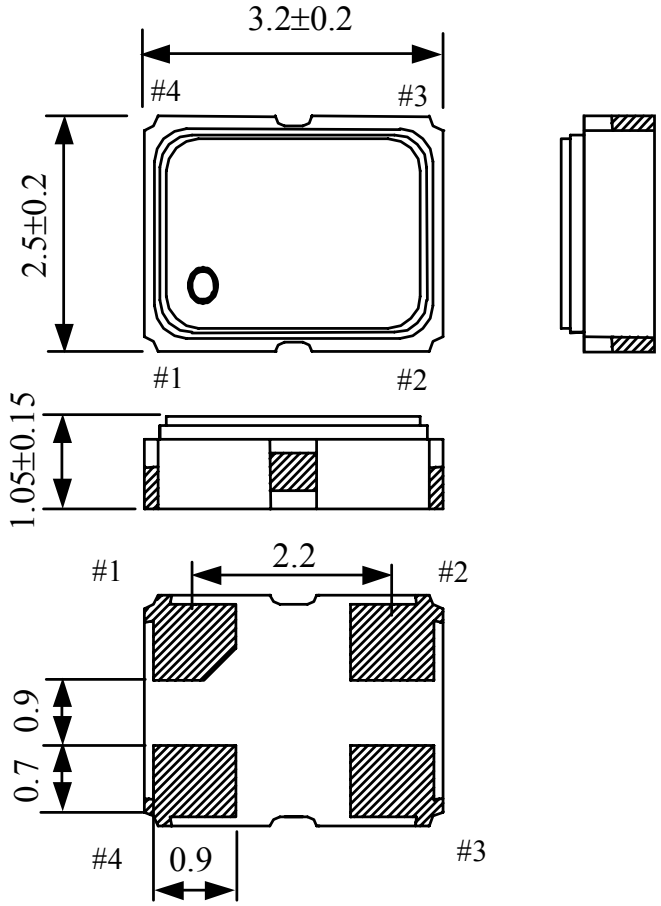
*3 Initial value shall be measured after 24 h storage at room temperature after pre-conditioning.
Pre-conditioning: Reflow (3 time)

Convection reflow condition (Ref. IPC/JEDEC J-STD-020D.1)



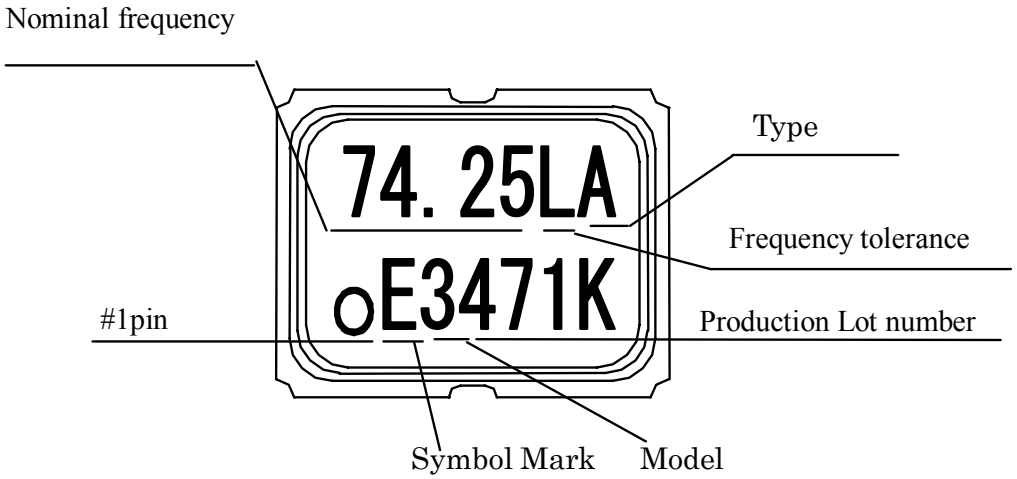
[9] Dimensions and marking layout

1) Dimensions



Terminal treatment : Au plating
Unit : mm

2) Marking layout



- The above marking layout shows only marking contents and their approximate position and it is not for font, size and exact position.
- Output frequency shall indicate 5 digits (include decimal point), if the value of frequency over 5 digits, the least significant digits will be omitted.

[10] Notes

1) This device is made with C-MOS IC.
Please take necessary precautions to prevent damage due to electrical static discharge.

2) Seiko Epson recommends a 0.01 μF to 0.1 μF capacitor must be connected near Vcc between Vcc and GND to obtain stable operation and protect against power line ripple.

3) Vcc and GND pattern shall be as large as possible so that high frequency impedance shall be small.

4) Seiko Epson cannot recommend putting filtering element into power line so as to reduce noise. Oscillator might be unstable oscillation because high frequency impedance of power line becomes higher. When use filtering element, please verify electrical construction and or element's spec.

5) Seiko Epson doesn't recommend to power on from intermediate electric voltage or extreme fast power on, those powering conditions may cause no oscillation or abnormal oscillation.

6) Power ripple: 200 mV P-P max. Start up time (0 %V_{CC}→90 %V_{CC}) of power source should be between 150 μs to 500ms.

7) A long output line may cause irregular output, so try to make the output line as short as possible.

8) Other high-level signal lines may cause incorrect operation, so please do not place high level signal line close to this device.

9) This device contains a crystal resonator, so please don't expose excessive shock or vibration. Seiko Epson recommends store device under normal temperature and humidity to keep the specification.

10) An automatic insertion is available, however, the internal crystal resonator might be damaged in case that too much shock or vibration is applied by machine condition.
Be sure to check your machine condition in advance.

11) Ultrasonic cleaning can be used on the SG-8003CE, however, since the oscillator might be damaged under some conditions, please exercise in advance.

12) Seiko Epson recommends to use and store under room temperature and normal humidity to secure frequency accuracy and prevent moisture.

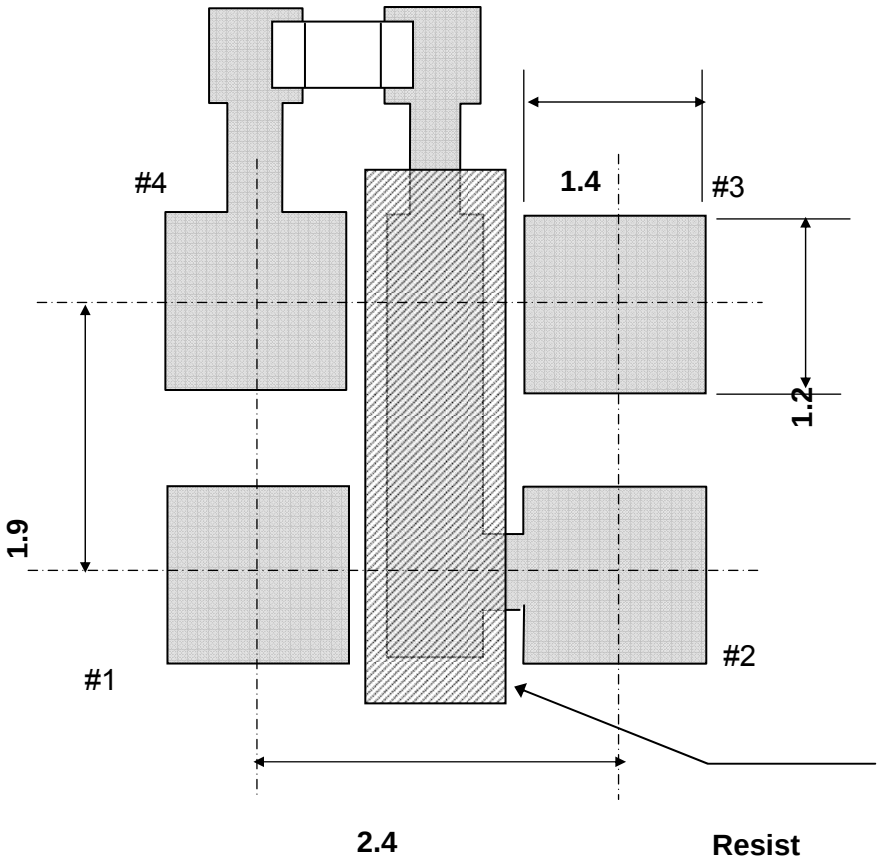
13) OE-pin has pull-up resistor internally. The resistor value is switched depending on input voltage. Please refer to electrical characteristics. And if OE-pin is not controlled please connect it to Vcc-pin.

14) Lid is electrically disconnected to package.
However output frequency might be affected when apply voltage to Lid.

[11] Recommendable patterning

The soldering pad sample indicated as like following:

Soldering position (Unit : mm)



Output frequency list

SG-8003CE PD

No.	Output frequency	Frequency stability [1×10^{-6}]	Operating temperature range [°C]	Model No.	Date	Note
1	74.25 MHz	L : ± 50	-40 ~ +85	Q33519EA0001800	’14.07.14	

TAPING SPECIFICATION

Ⅰ. Application

This standard will apply to 3.2×2.5 Ceramic package.

Spec：CE package

Ⅱ. Contents

Item No.	Item	Page
〔1〕	Taping specification	1 to 2
〔2〕	Inner carton	3
〔3〕	Shipping carton	
〔4〕	Marking	4
〔5〕	Quantity	
〔6〕	Storage environment	
〔7〕	Handling	

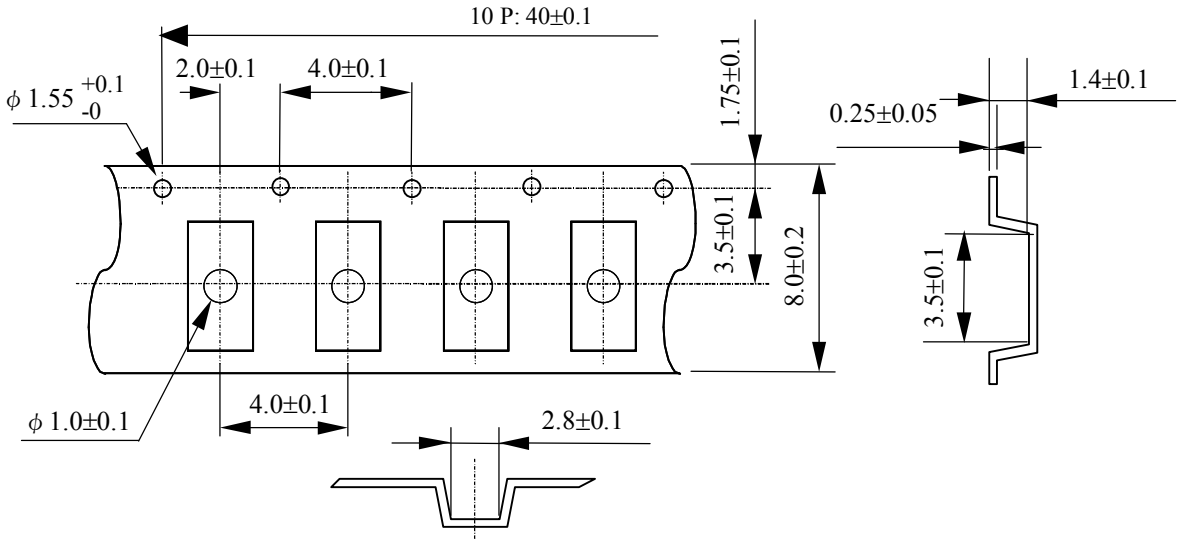
〔1〕 Taping specification

Subject to「EIA-481」and「IEC-60286」

(1) Tape dimensions

Material of the carrier tape : ＰＳ

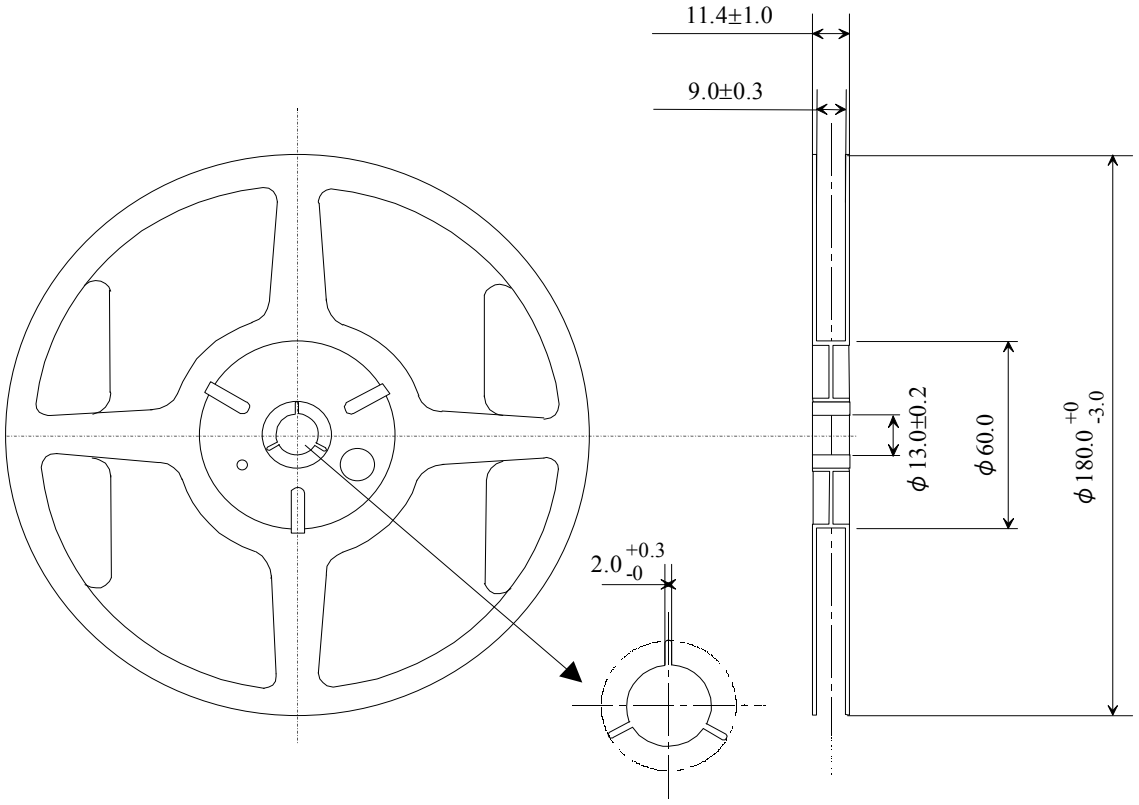
Material of the top tape : PET+PE



Unit : mm

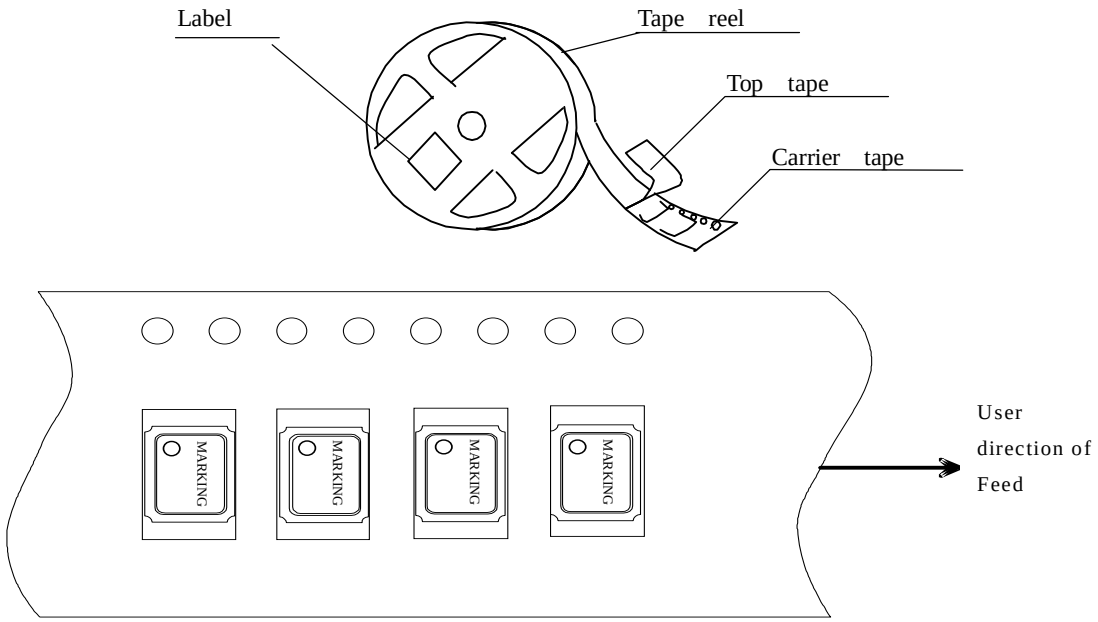
(2) Reel dimensions

Material of the reel : Conductive polystyrene

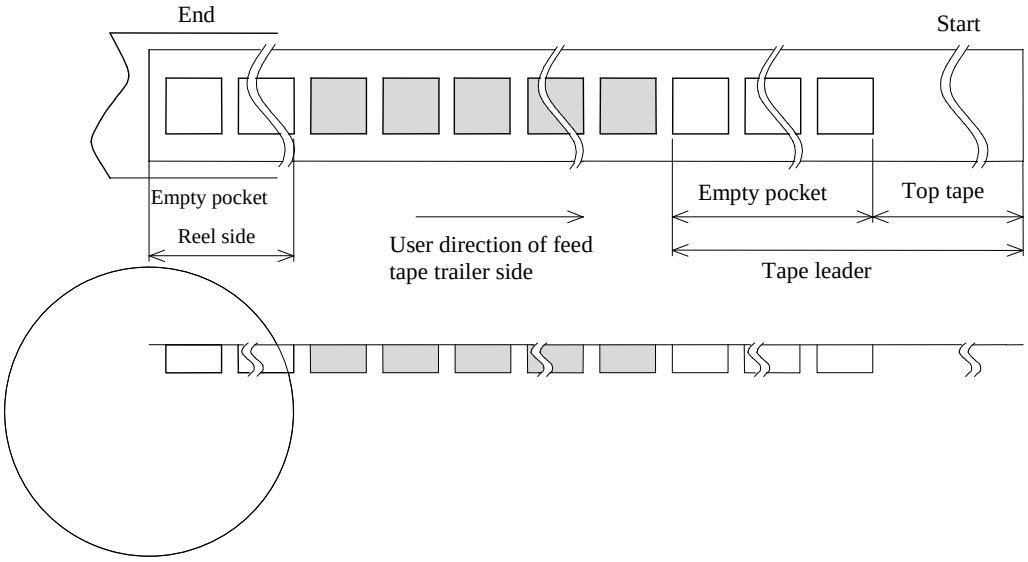


(3) Packing

①Tape & reel



②Start & end point



Item		Empty space
Tape leader	Top tape	Min. 1 000 mm
	Carrier tape	Min. 160 mm
Tape trailer	Top tape	Min. 0 mm
	Carrier tape	Min. 160 mm

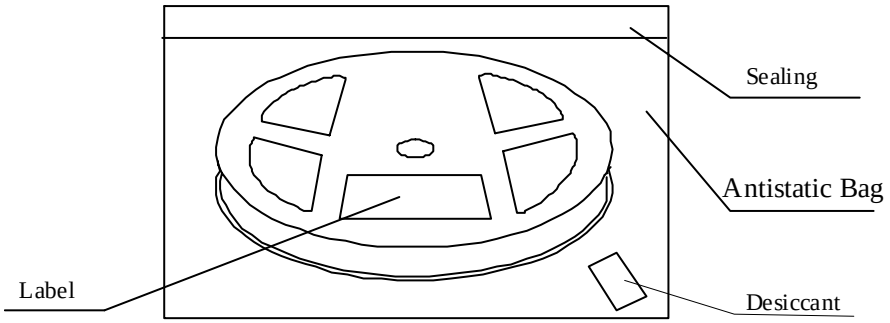
(4) Peel force of the cover tape

① angle : cover tape during peel off and the direction of unreeling shall be 165° to 180°.

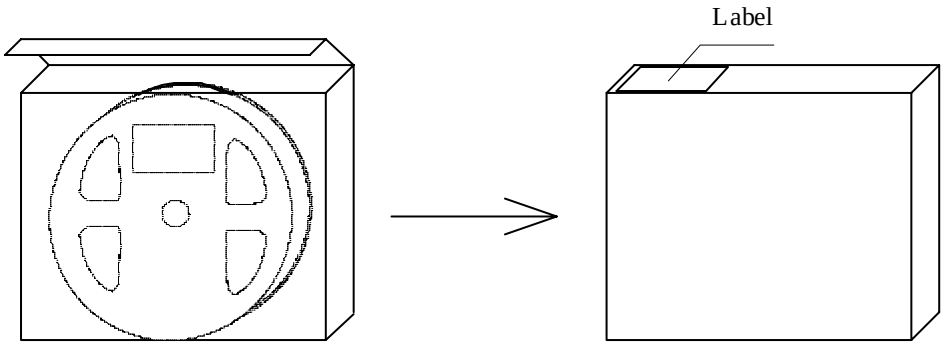
② peel speed : 300 mm / min.

〔2〕 Inner carton

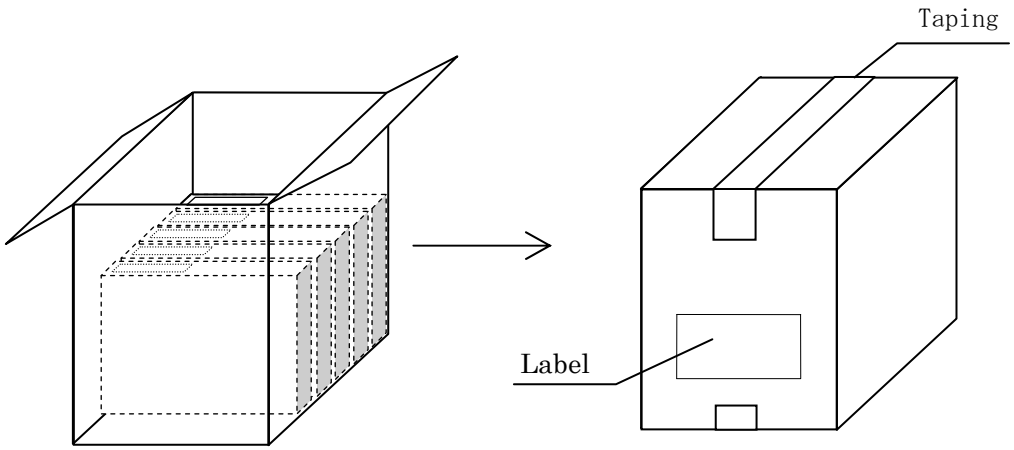
a) Packing to antistatic bag



b) Packing to inner carton



〔3〕 Shipping carton



〔4〕 Marking

(1) Reel marking

・Reel marking shall consist of :

1) Parts name
2) Quantity
3) Manufacturing date or symbol
4) Manufacturer's date or symbol
5) Others (if necessary)

(2) Inner carton marking

・Same as reel marking.

(3) Shipping carton marking

・Shipping carton marking shall consist of :

1) Parts name
2) Quantity

〔5〕 Quantity

・ 2,000 pcs./reel

〔6〕 Storage environment

(1) Before open the packing, we recommend to keep less than +30 °C and 85 %RH of Humidity, and to use it less than 6 months after delivery.

(2) We recommend to open Package in immediately before use. After open Package, We recommend to keeps less than 6 month. No need dry air before soldering work if it is less than temperature +30 °C, 85 humidity %RH.

(3) Not to expose the sun.

(4) Not to storage with some erosive chemicals.

(5) Nothing is allowed to put on the reel or carton to prevent mechanical damage.

〔7〕 Handling

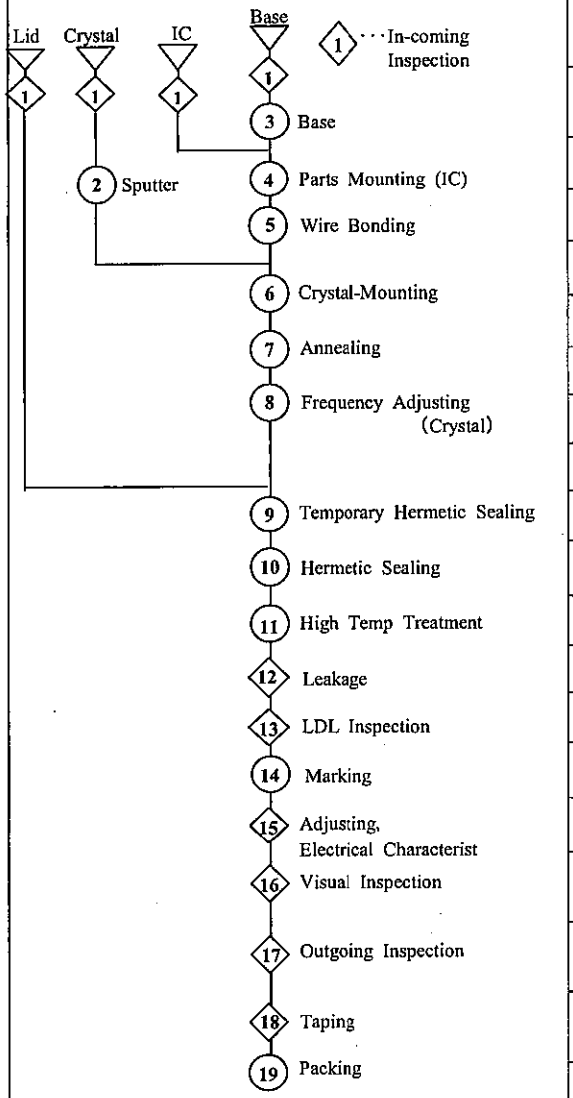
・To handle with care to prevent the damage of tape, reel and products.

- PROCESS QUALITY CONTROL -

No. SG8003CE - 00 - AME – 3 CRYSTAL OSCILLATOR : SG-8003CE/SG-320PxP

2012.6.7

Manufacturing process chart

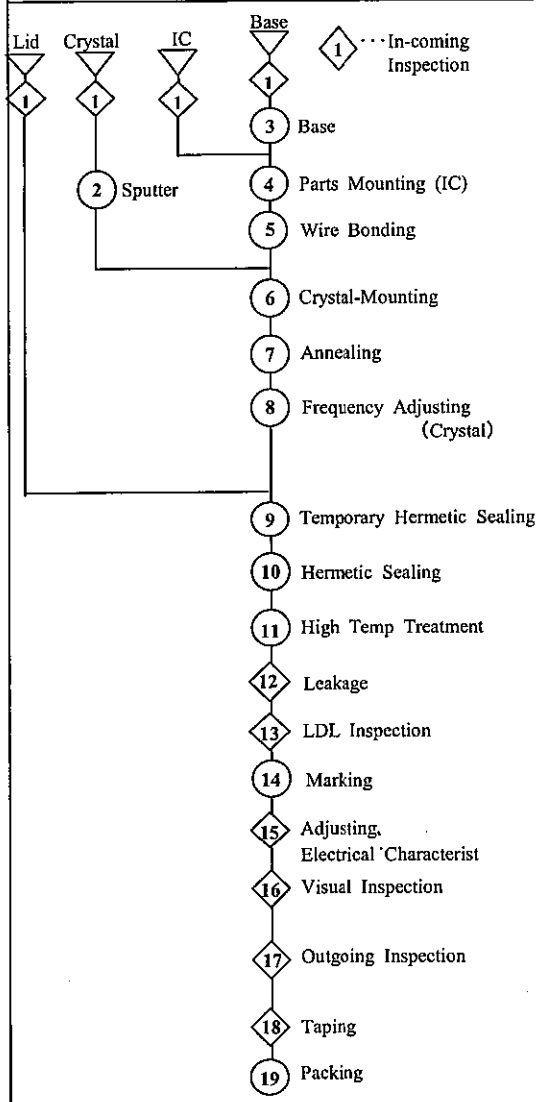


No.	Section In Charge	Standards	Inspection, Control Item	Instruments	Inspection Methods	Record
1	Inspection Section	Purchasing specification Incoming inspection standard	Appearance Dimension	Microscope	Sampling	Data sheet
2	Malaysia Plant (Production Section)	Manufacturing instruction sheet	Appearance Peeling strength Frequency	Microscope Scratch CI Meter	Sampling	Data sheet
3	Malaysia Plant (Production Section)	Manufacturing instruction sheet	Appearance	Microscope	Sampling	Data sheet
4	Malaysia Plant (Production Section)	Manufacturing instruction sheet	Appearance	Microscope	Sampling	Data sheet
5	Malaysia Plant (Production Section)	Manufacturing instruction sheet	Bonding strength Appearance	Gauge Microscope	Sampling	Data sheet
6	Malaysia Plant (Production Section)	Manufacturing instruction sheet	Appearance	Microscope	Sampling	Data sheet
7	Malaysia Plant (Production Section)	Manufacturing instruction sheet	—	—	—	—
8	Malaysia Plant (Production Section)	Manufacturing instruction sheet	—	—	—	—
9	Malaysia Plant (Production Section)	Manufacturing instruction sheet	Appearance	Microscope	Sampling	Data sheet
10	Malaysia Plant (Production Section)	Manufacturing instruction sheet	Appearance Frequency	Microscope Counter	Sampling Sampling	Data sheet
11	Malaysia Plant (Production Section)	Manufacturing instruction sheet	—	—	—	—
12	Malaysia Plant (Production Section)	Manufacturing instruction sheet	Leakage inspection	Measuring equipment	100% Inspection	Data sheet
13	Malaysia Plant (Production Section)	Manufacturing instruction sheet	Characteristic inspection	Measuring equipment	100% Inspection	
14	Malaysia Plant (Production Section)	Manufacturing instruction sheet	Appearance	Microscope	Sampling	Data sheet
15	Malaysia Plant (Production Section)	Manufacturing instruction sheet	Electrical characteristic Master check	Measuring equipment	100% Inspection One/Day	Data sheet
16	Malaysia Plant (Production Section)	Manufacturing instruction sheet	Appearance Master check	Microscope	Sampling One/Day	Data sheet
17	Malaysia Plant (Inspection Section)	Delivery specifications Outgoing inspection standard	Electrical characteristic Appearance Master check	Measuring equipment Visual inspection	Sampling One/Day	Data sheet
18	Malaysia Plant (Production Section)	Manufacturing instruction sheet	Tape peeling strength Frequency check function	Peeling strength test machine	Sampling One/Day	Data sheet
19	Malaysia Plant (Production Control Section)	Manufacturing instruction sheet Daily shipping list	Customers Type Quantity	—	—	Delivery Slip

- PROCESS QUALITY CONTROL -

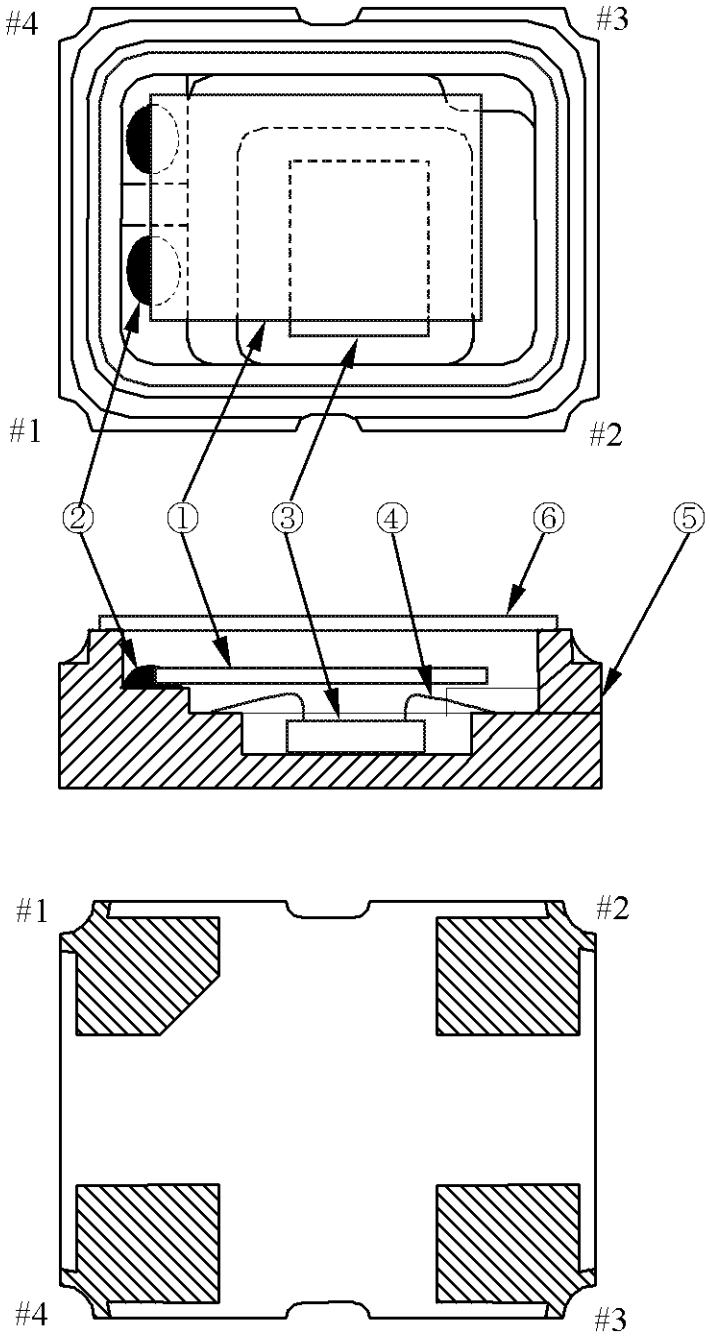
No. SG8003CE - 00 - ASE – 4 CRYSTAL OSCILLATOR : SG-8003CE/SG-320P*P

2012.6.7



No.	Section In Charge	Standards	Inspection, Control Item	Instruments	Inspection Methods	Record
1	Inspection Section	Purchasing specification Incoming inspection standard	Appearance Dimension	Microscope	Sampling	Data sheet
2	China Plant (Production Section)	Manufacturing instruction sheet	Appearance Peeling strength Frequency	Microscope Scratch CI Meter	Sampling	Data sheet
3	China Plant (Production Section)	Manufacturing instruction sheet	Appearance	Microscope	Sampling	Data sheet
4	China Plant (Production Section)	Manufacturing instruction sheet	Appearance	Microscope	Sampling	Data sheet
5	China Plant (Production Section)	Manufacturing instruction sheet	Bonding strength Appearance	Gauge Microscope	Sampling	Data sheet
6	China Plant (Production Section)	Manufacturing instruction sheet	Appearance	Microscope	Sampling	Data sheet
7	China Plant (Production Section)	Manufacturing instruction sheet	—	—	—	—
8	China Plant (Production Section)	Manufacturing instruction sheet	—	—	—	—
9	China Plant (Production Section)	Manufacturing instruction sheet	Appearance	Microscope	Sampling	Data sheet
10	China Plant (Production Section)	Manufacturing instruction sheet	Appearance Frequency	Microscope Counter	Sampling Sampling	Data sheet
11	China Plant (Production Section)	Manufacturing instruction sheet	—	—	—	—
12	China Plant (Production Section)	Manufacturing instruction sheet	Leakage inspection	Measuring equipment	100% Inspection	Data sheet
13	China Plant (Production Section)	Manufacturing instruction sheet	Characteristic inspection	Measuring equipment	100% Inspection	
14	China Plant (Production Section)	Manufacturing instruction sheet	Appearance	Microscope	Sampling	Data sheet
15	China Plant (Production Section)	Manufacturing instruction sheet	Electrical characteristic Master check	Measuring equipment	100% Inspection One/Day	Data sheet
16	China Plant (Production Section)	Manufacturing instruction sheet	Appearance Master check	Microscope	Sampling One/Day	Data sheet
17	China Plant (Inspection Section)	Delivery specifications Outgoing inspection standard	Electrical characteristic Appearance Master check	Measuring equipment Visual inspection	Sampling One/Day	Data sheet
18	China Plant (Production Section)	Manufacturing instruction sheet	Tape peeling strength Frequency check function	Peeling strength test machine	Sampling One/Day	Data sheet
19	China Plant (Production Control Section)	Manufacturing instruction sheet Daily shipping list	Customers Type Quantity	—	—	Delivery Slip

Structure diagram SG-8003CE



LIST		
Name of part		Material
①	Crystal chip	AT cut
②	Crystal adhesive	Ag paste
③	IC	C-MOS
	IC conductive adhesive	Ag paste
④	Bonding wire	Au
⑤	Package	Ceramic (Al_2O_2)
⑥	Cap	Kovar